

### 600V N-Channel Power MOSFET

#### Features

- High Voltage:  $BV_{DSS}=600V(\text{Min.})$
- $I_D : 4A$
- Robust high voltage termination
- Avalanche energy specified
- Fast diode recovery time

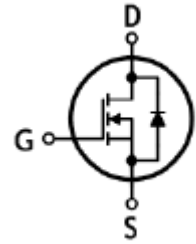
#### Application

- Ballast Bridge
- Switch Mode Power Supplier
- Power Factor Correction
- Lighting



G D S

I-PAK (Short Lead)



#### Ordering Information

Type NO	Marking	Package Code
WMI4N60U	4N60IU	TO-251

#### Absolute maximum ratings ( $T_C=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Rating	Unit	
Drain-source voltage	$V_{DSS}$	600	V	
Gate-source voltage	$V_{GSS}$	$\pm 30$	V	
Drain current (DC) *	$I_D$	$T_C=25^\circ\text{C}$	4.0	A
		$T_C=100^\circ\text{C}$	2.53	A
Drain current (Pulsed) *	$I_{DM}$	16	A	
Single avalanche energy ②	$E_{AS}$	86.7	mJ	
Repetitive avalanche current ①	$I_{AR}$	4.0	A	
Repetitive avalanche energy ①	$E_{AR}$	3.2	Mj	
Power dissipation	$P_D$	52	W	
Junction temperature	$T_J$	150	$^\circ\text{C}$	
Storage temperature range	$T_{stg}$	-55~150	$^\circ\text{C}$	

\* Limited by maximum junction temperature

Characteristic	Symbol	Typ.	Max	Unit	
Thermal resistance	Junction-case	$R_{th(J-C)}$	-	2.4	$^\circ\text{C}/\text{W}$
	Junction-ambient	$R_{th(J-A)}$	-	83	

**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage	$BV_{DSS}$	$I_D=250\ \mu\text{A}, V_{GS}=0\text{V}$	600	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$I_D=250\ \mu\text{A}, V_{DS}=V_{GS}$	3.0	-	5.0	V
Drain-source cut-off current	$I_{DSS}$	$V_{DS}=600\text{V}, V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
		$V_{DS}=600\text{V}, T_C=150^\circ\text{C}$			100	$\mu\text{A}$
Gate leakage current	$I_{GSS}$	$V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$	-	-	$\pm 100$	nA
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}, I_D=2\text{A}$	-	2.1	2.5	$\Omega$
Forward transfer conductance ③	$g_{fs}$	$V_{DS}=10\text{V}, I_D=2\text{A}$	-	5	-	S
Input capacitance	$C_{iss}$	$V_{DS}=25\text{V}, V_{GS}=0\text{V}$ $f=1\ \text{MHz}$	-	720	-	pF
Output capacitance	$C_{oss}$		-	53	-	
Reverse transfer capacitance	$C_{rss}$		-	6.3	-	
Turn-on delay time ③④	$t_{d(on)}$	$V_{DS}=300\text{V}, I_D=4\text{A}$ $R_G=25\ \Omega$	-	47	-	ns
Rise time ③④	$t_r$		-	33	-	
Turn-off delay time ③④	$t_{d(off)}$		-	78	-	
Fall time ③④	$t_f$		-	24	-	
Total gate charge ③④	$Q_g$	$V_{DS}=480\text{V}, V_{GS}=10\text{V}$ $I_D=4\text{A}$	-	12	15	nC
Gate-source charge ③④	$Q_{gs}$		-	5	-	
Gate-drain charge ③④	$Q_{gd}$		-	2.5	-	

**Source-Drain Diode Ratings and Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Test Condition	Min	Typ	Max	Unit
Source current (DC)	$I_S$	Integral reverse diode in the MOSFET	-	-	4.0	A
Source current (Pulsed)	$I_{SM}$		-	-	16.0	
Forward voltage	$V_{SD}$	$V_{GS}=0\text{V}, I_{SD}=4\text{A}$	-	-	1.4	V
Reverse recovery time ③④	$t_{rr}$	$I_{SD}=4\text{A}, V_{GS}=0\text{V}$ $dI_F/dt=100\text{A}/\mu\text{s}$	-	472	-	ns
Reverse recovery charge ③④	$Q_{rr}$		-	0.98	-	$\mu\text{C}$

Note ;

1. Repetitive rating : Pulse width limited by safe operating area
2.  $L=10\text{mH}, I_{AS}=4\text{A}, V_{DD}=50\text{V}, R_G=25\ \Omega$ , Starting  $T_J=25^\circ\text{C}$
3. Pulse Test : Pulse width  $\leq 300\ \mu\text{s}$ , Duty cycle  $\leq 2\%$
4. Essentially independent of operating temperature typical characteristics

Electrical Characteristic Curves

Fig. 1 Typical Output Characteristics

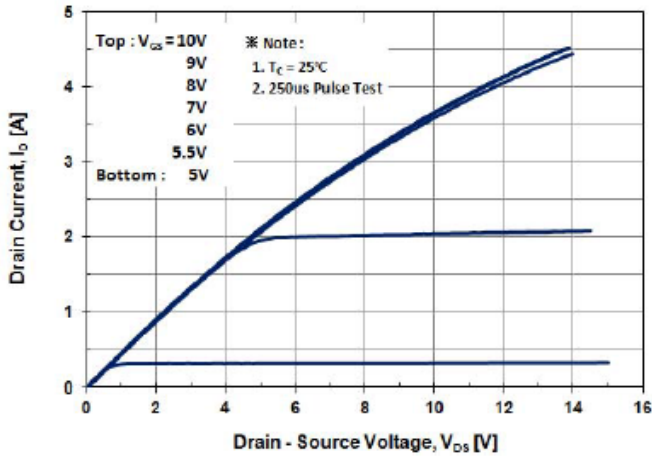


Fig. 2 Typical Output Characteristics

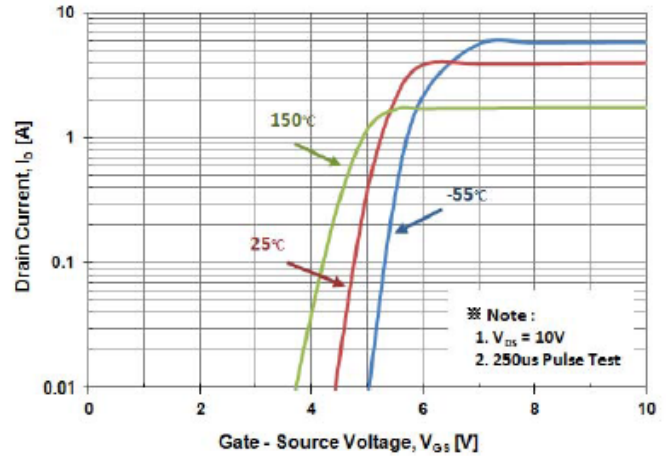


Fig. 3 On-Resistance Variation with Drain Current and Gate Voltage

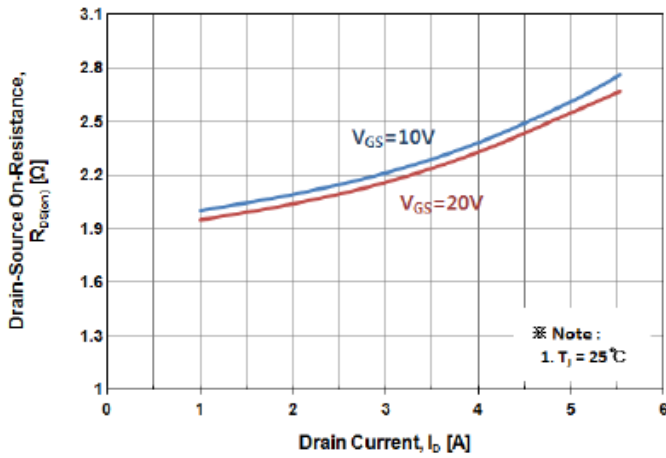


Fig. 4 Body Diode Forward Voltage Variation with Source Current

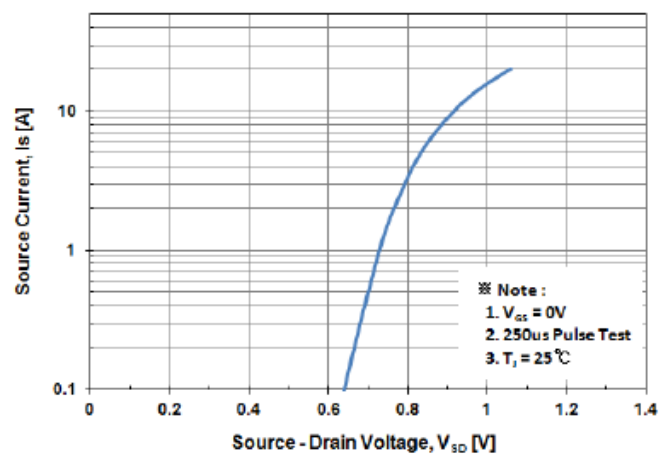


Fig. 5 Typical Capacitance Characteristics

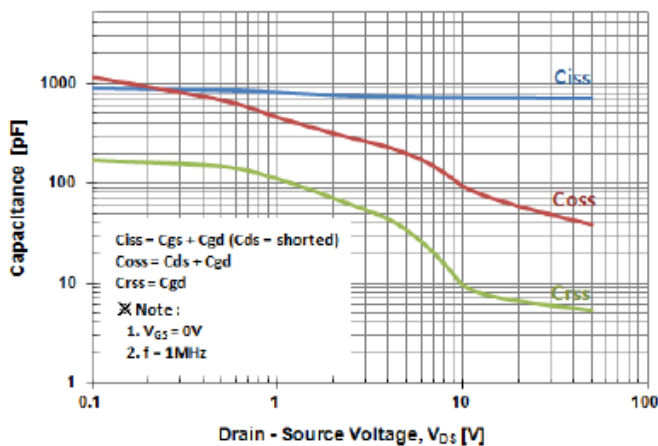
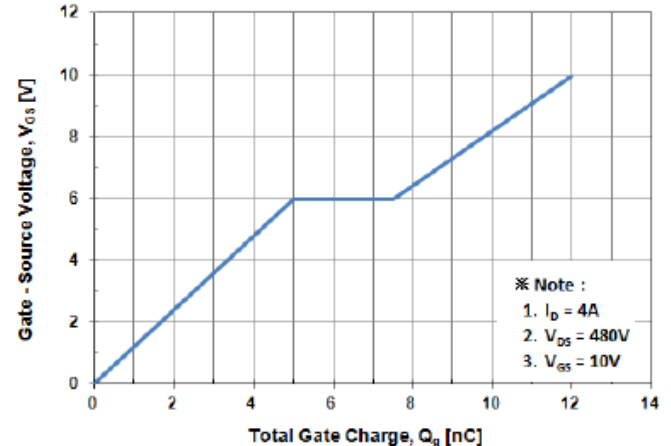


Fig. 6 Typical Total Gate Charge Characteristics



## Electrical Characteristic Curves

Fig. 7 Breakdown Voltage Variation vs. Temperature

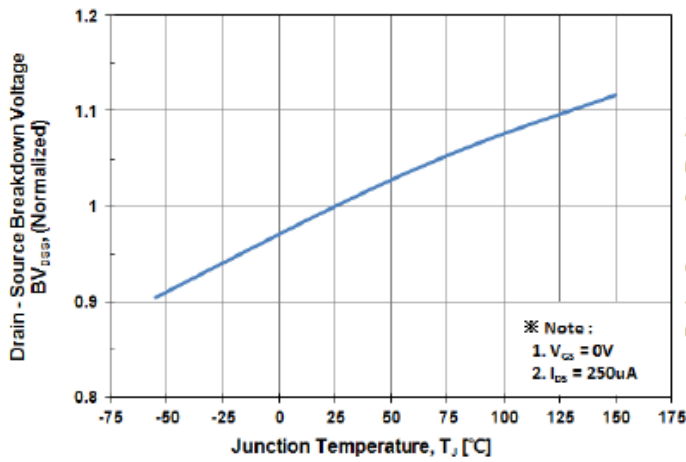


Fig. 8 On-Resistance Variation vs. Temperature

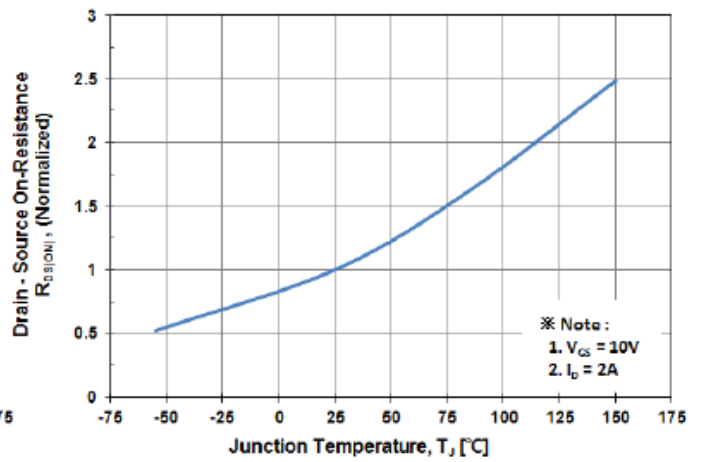


Fig. 9 Maximum Drain Current vs. Case Temperature

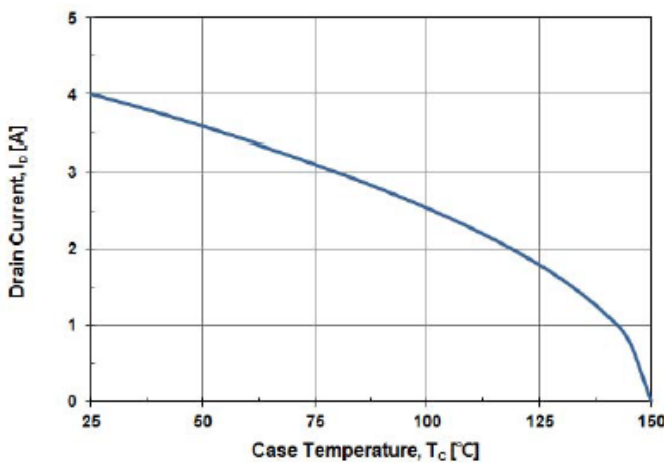


Fig. 10 Maximum Safe Operating Area

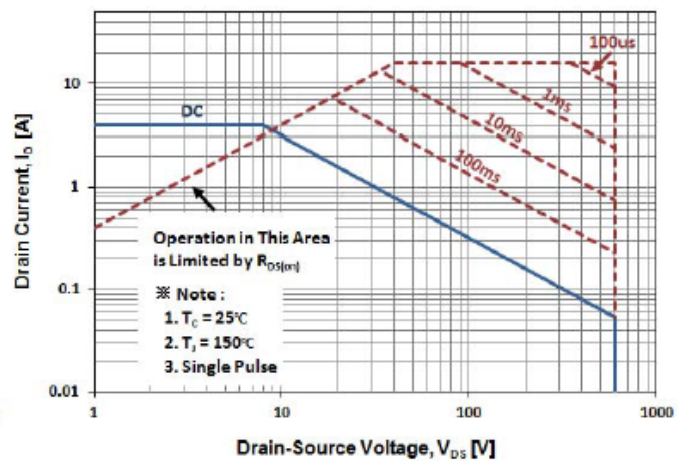
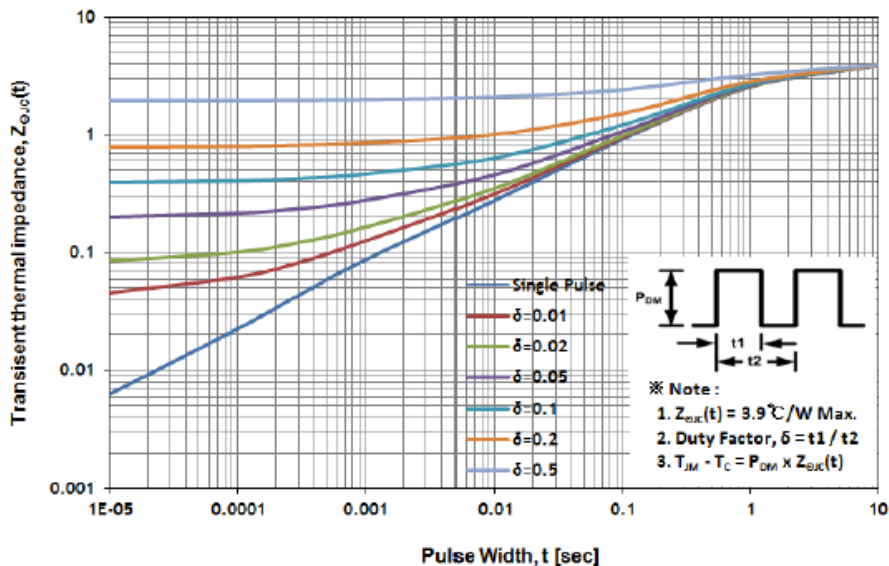
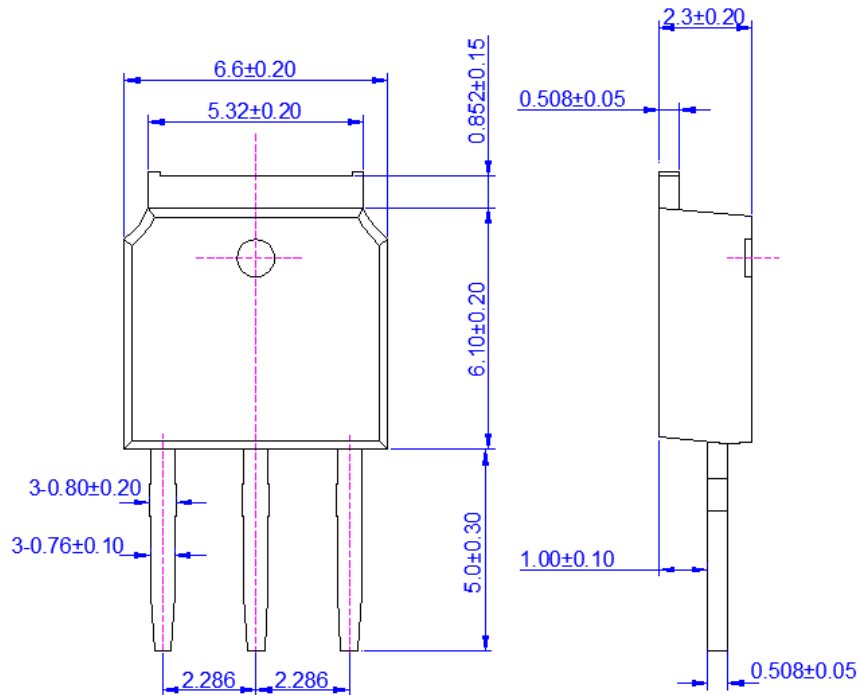


Fig. 11 Transient Thermal Impedance

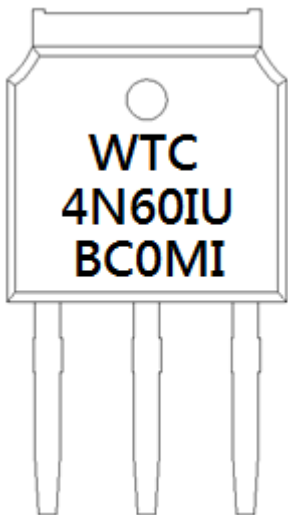


Outline Dimension : TO-251



Unit : mm

**Marking Diagram**



First Line	WTC	Company Name	
Second Line	4N60IU	Product Code	
Third Line	BC0MI	1st ( Year Code )	A-2010 B-2011 C-2012 ...
		2nd ( Month Code )	A-Jan B-Feb C-Mar D-Apr E-May F-Jun G-Jul H-Aug I-Sep J-Oct K-Nov L-Dec
		3rd ( Lot Code )	0-1 , A-9
		4th (Product Code )	M-MOS , T-Transistor
		5th (Package Code )	D-TO-252 , I-TO-251
		6th ( Spec Code )	( Reserve )